

Internship Course Application Form

Completed application form together with supporting documents should be submitted to the Course Coordinator of the internship course BEFORE the commencement of the internship. Post internship application will not be considered.

1. To be completed by Student

Personal Particulars

(* Please delete as appropriate)

Name of Student: _____ 姓名(中文): _____

Last Name First Name

University No.: _____ Year of study: _____ CGPA: _____

Programme: * BSc / BSc(ActuarSc)/
BASc(AppliedAI) Major: _____ * Second major / Minor: _____

Contact Tel No: (Home) _____ (Mobile) _____ Email address: _____

Details of Internship

(Please attach the contract of the internship)

Company name / Name of External
Institution: _____ Supervisor: _____

Telephone number of Email of External
External Supervisor: _____ Supervisor: _____

Name of Internal Email of Internal
Supervisor (if applicable): _____ Supervisor (if applicable): _____

Internship period: From _____ to _____
(day / month / year)

Mode of Internship: Full-time, and I have to apply for leave of absence in the * first / second semester of _____ to the Faculty
(please tick as appropriate) Office separately
 Full-time in summer only
 Part-time

Job nature / Job description:
(Please attach details) _____

Goal of internship: _____

I declare I would have completed at least 24 credits of advanced level courses in the major BEFORE the commencement of the internship, otherwise, I cannot enroll in the internship course eventually. I also understand I cannot drop this course after my submission of application under normal circumstances.

Student's signature: _____ Date: _____

2. To be completed by Course Coordinator

The enrollment in internship course (course code and title) _____ is * approved
/ not approved.

(* Please delete as appropriate)

Name of Course Coordinator: _____ Department/school: _____

Signature: _____ Date: _____

THE UNIVERSITY OF HONG KONG

FACULTY OF SCIENCE

List of Internship Course Coordinators

Major / Programme	Course Coordinator	Departmental Office, Telephone & Email Address
APAI4766 Applied AI Internship	Dr Adela S M LAU	Office: Rm 303, Run Run Shaw Bldg Tel: 3917 2466 Email: ug_enquiry@saas.hku.hk
BIOC4966 Biochemistry internship	Dr Bonny B H YUEN	Office: Rm L4-54, Laboratory Block, Faculty of Medicine Bldg, 21 Sassoon Road Tel: 3917 9500 Email: yuenbbh@hku.hk
BIOL4861 Ecology & biodiversity internship	Dr Thiagarajan VENGATESEN	Office: Rm 2S03, Kadoorie Biological Sciences Bldg Tel: 2299 0601 Email: rajan@hku.hk
BIOL4962 Food & nutritional science internship	Dr Jetty C Y LEE	Office: Rm 6S09, Kadoorie Biological Sciences Bldg Tel: 2299 0318 Email: jettylee@hku.hk
BIOL4963 Molecular biology & biotechnology internship	Dr A YAN	Office: Rm 7S01, Kadoorie Biological Sciences Bldg Tel: 2299 0864 Email: ayan8@hku.hk
BIOL4964 Biological sciences internship	Dr Gary Ying Wai CHAN	Office: Rm 4N11, Kadoorie Biological Sciences Bldg Tel: 2299 0849 Email: gywchan@hku.hk
CHEM4966 Chemistry internship	Dr Ho Yu AU-YEUNG	Office: Rm 503, Chong Yuet Ming Chemistry Bldg Tel: 2219 4697 Email: hoyuay@hku.hk
EASC4966 Earth sciences internship	Dr Man Ching CHEUNG	Office: JL 1/F, James Lee Science Bldg Tel: 2241 5472 Email: hmcc@hku.hk
ENTR4966 Entrepreneurship internship	Dr Rocky C S LAW	Office: Room 110, Hui Oi Chow Science Building Tel: 3917 1285 Email: rockylaw@hku.hk
ENVS4966 Environmental science internship	Dr Caroline E DINGLE	Office: Rm 6S13, Kadoorie Biological Sciences Bldg Tel: 2299 0674 Email: cdingle@hku.hk
MATH4966 Mathematics internship	Dr Tak Kwong WONG	Office: Room 317, Run Run Shaw Building Tel: 2857 8579 Email: takkwong@maths.hku.hk
PHYS4966 Physics internship	Dr Francis Chi Chung LING	Office: Rm 417, Chong Yuet Ming Physics Bldg Tel: 2241 5248 Email: ccling@hku.hk
STAT4766 Statistics internship	Dr Chi Wai KWAN	Office: Rm 236, Run Run Shaw Bldg Tel: 3917 8317 Email: cwkwon@hku.hk
STAT4767 Actuarial science internship	Dr Andres Gustavo BENCHIMOL	Office: Rm 303, Run Run Shaw Bldg Tel: 3917 2466 Email: ug_enquiry@saas.hku.hk

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